

Title (en)

PRIMARY SHAPING METHOD FOR A COMPONENT COMPRISING A MICROSTRUCTURED FUNCTIONAL ELEMENT

Title (de)

FORMVERFAHREN FÜR EIN BAUTEIL MIT MIKROSTRUKTUR-FUNKTIONSELEMENT

Title (fr)

PROCEDE DE TRANSFORMATION PRIMAIRE D'UN COMPOSANT AYANT UN ELEMENT FONCTIONNEL A MICROSTRUCTURE

Publication

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Application

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Abstract (en)

[origin: WO2004087350A2] The invention relates to a primary shaping method for a component comprising at least one microstructured functional element, which is configured intentionally with a defined structure, in relief, at a defined point on the surface of the component in order to specifically fulfil a function. Said element has a characteristic dimension in the micrometer range in at least one spatial direction. The component is shaped from a substantially metallic material using a mould. The aim of the invention is to simplify and accelerate a primary shaping method of this type, making it more cost-effective and attractive for mass-production and use on a large scale, thus opening new avenues of application. To achieve this, at least one functional element is formed in a negative impression that is configured on the surface of the mould. The invention also relates to a mould, a core, a core box, a model, an original form and a master pattern for carrying out said primary shaping method.

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**B33Y 80/00** (2014.12 - EP US)

Citation (search report)

See references of WO 2004087350A2

Citation (examination)

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- US 6435255 B1 20020820 - KALADJIAN VAHE [US]
- US 2002144515 A1 20021010 - ZIEVERINK ROBERT M [US]

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